PRODUCT SPECIFICATIONS

CS1602B-D-YSNFDYN-122

V1.0

March 5, 2008

Easterntronic LCD Group

REVISION RECORD

Version	Description	Date
V1.0		March 5 2009

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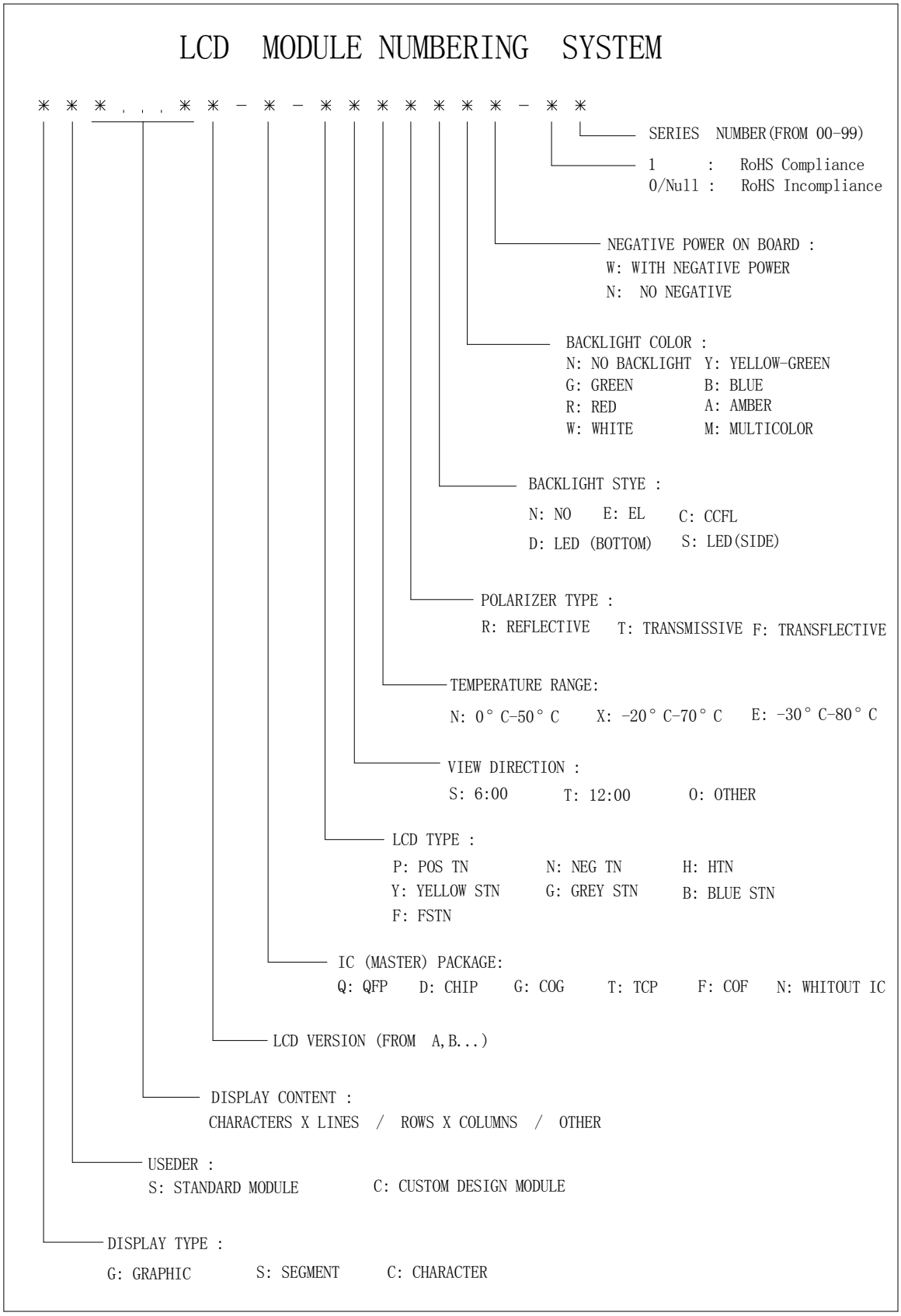
1. LCD MODULE NUMBERING SYSTEM

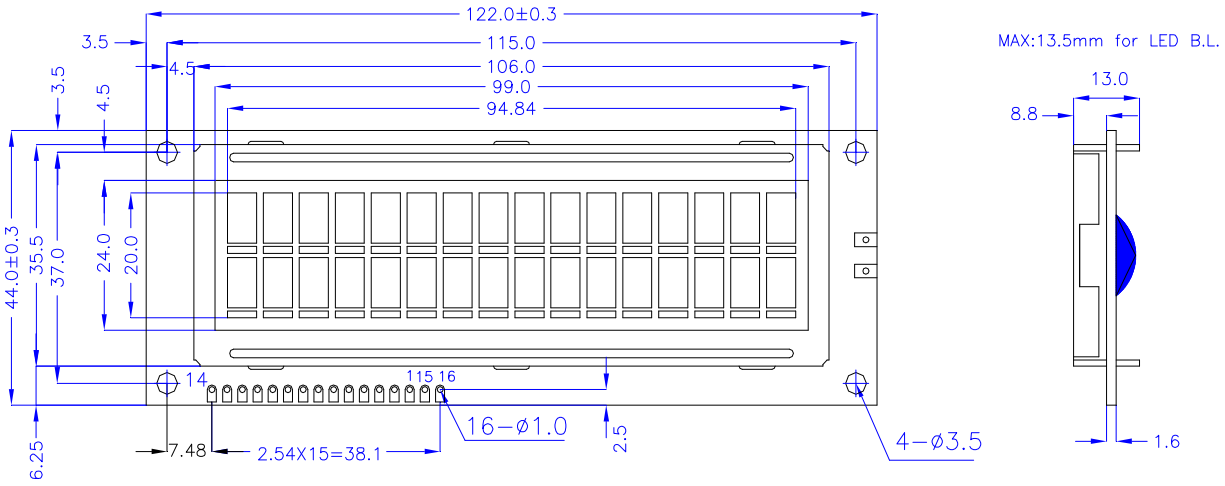


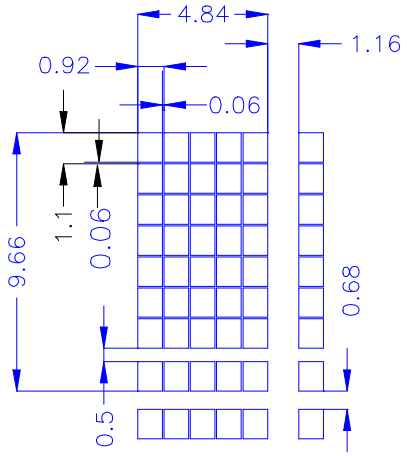
2. TYPE NUMBER AND DESCRIPTION

Type Number	:	CS1602B-D-YSNFDYN-122
Description	:	16 Characters X 2 Lines
LCD Panel	:	Yellow-Green STN, Positive, Transflective
Duty and Bias	:	1/16 duty and 1/5 bias
Logic Voltage	:	5.0V
Viewing angle	:	6H
BackLight	:	Bottom, Yellow-Green LED
Operating Temperature	:	0˚C--50˚C
Storage Temperature	:	-10˚C --60˚C
Controller	:	ST7066U-0T or equivalent
IC package	:	Bonding

3. MECHANICAL SPECIFICATIONS:

ITEM	STANDARD VALUE	UNIT
NUMBER OF CHARACTERS	16 CHARACTERS X 2 LINES	
CHARACTER FORMAT	5 X 7 DOTS with CURSOR	
MODULE DIMENSION	122.0(W) X 44.0(H) X 13.0(T)	mm
EFFECTTVE DISPLAY AREA	99.0(W) X 24.0(H)	mm
CHARACTER SIZE	4.84 (W) X 9.66(H)	mm
CHARACTER PITCH	6.0 (W) X 10.34(H)	mm
DOT SIZE	0.92(W) X 1.10(H)	mm
DOT PITCH	0.98(W) X 1.16(H)	mm
APPROX WEIGHT	60	g
LCD TYPE	Yellow-Green STN, Positive, Transflective	
DUTY AND BIAS	1/16 DUTY; 1/5 BIAS	
VIEWING DIRECTION	6:00	
BACK LIGHT	Bottom, Yellow-Green LED	





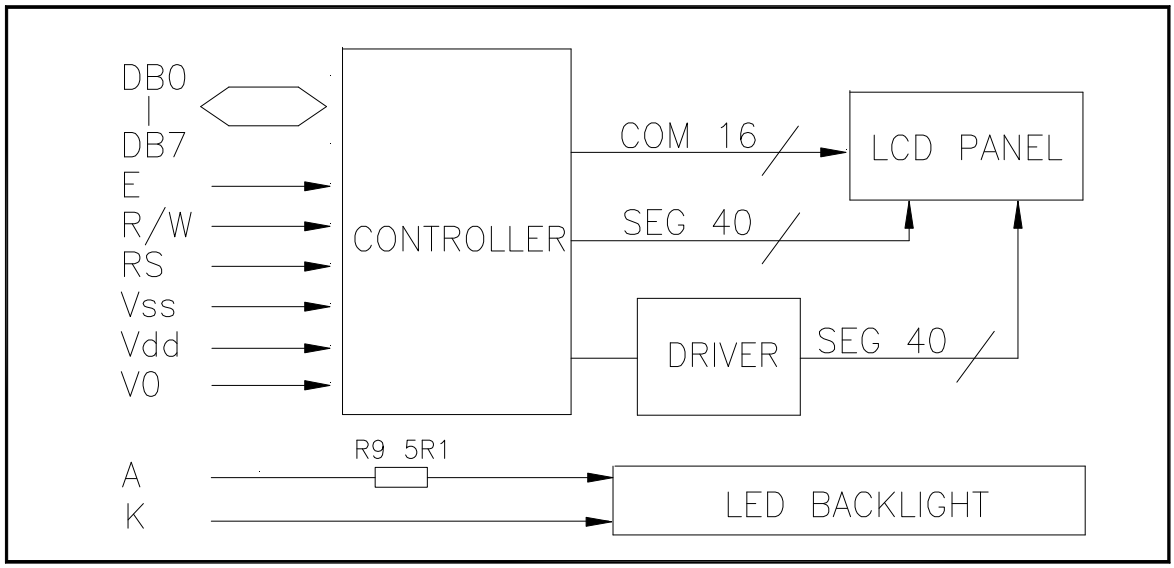
* Remark : Non-specified tolerance refers this model. (±0.2mm)

4. ELECTRICAL BLOCK DIAGRAM

4.1 PINS DEFINITION

PIN	SYMBOL	FUNCTION
1	Vss	Power Supply(0V,GND)
2	Vdd	Power Supply for Logic
3	Vo	Contrast Adjust
4	RS	Instruction/Data Register Select
5	R/W	Data Read/Write, L: Write; H: Read
6	E	Enable Signal
7-14	DB0-DB7	Data Bus Line
15	A	Power Supply for LED Backlight(+)
16	K	Power Supply for LED Backlight(-)

4.2 ELECTRICAL BLOCK DIAGRAM



4.3 DISPLAY CHARACTER ADDRESS CODE

DISPLAY POSITION	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DDRAM ADDRESS	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F

5. ABSOLUTE MAXIMUM RATINGS

5.1 Electrical Maximum Ratings (Ta=25deg C)

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Supply Voltage (Logic)	Vdd – Vss	-	-0.3	7.0	V
Supply Voltage (LCD Drive)	Vdd – V0	-	VDD-10	VDD+0.3	V
Input Voltage	Vi	-	-0.3	Vdd +0.3	V

5.2 Environmental Conditions

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Operating Temp	Topr	-	0	50	deg C
Storage Temp	Ttsg	-	-10	60	deg C

6. ELECTRICAL SPECIFICATIONS

6.1 Electrical Characteristics at Ta=25 deg C, Vdd = 5.0V + / - 5%

ITEM	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Supply Voltage (logic)	Vdd-Vss	-	4.5	5.0	5.5	V
Supply Voltage (LCD)	Vdd-V0	Vdd = 5V	4.2	4.5	4.8	V
Input signal voltage (for E, DB0-7,R/W,RS)	V-ih	“H” level	0.7VDD	-	Vdd	V
	V-il	“L” level	0	-	-	V
Supply Current (logic)	Icc	-	0.9	1.0	1.2	mA
Supply Current (LCD)	Io	-	0.15	0.22	0.27	mA
*Supply Curren(BackLight)	Vled	-	4.0	4.2	4.4	V
*Supply Current (LED)	If	-	-	260	350	mA
*Peak forward current(B/L)	Ifp	I mseo pulse 10% Duty Cycle	-	-	780	mA
*Power dissipation(B/L)	Pd		-	-	1100	mW

*For operation above 25℃，the If、Ifp&Pd must be derated, the current derating is -8.64 mA/℃ for DC drive and -20.64 mA/℃ for pulse drive,the power dissipation is -36.3 mW /℃.The Blacklight working current must not more than 60% of the Ifmax or Ifpmax according to the working temperature.

6.2 Timing Specifications at Ta = 25 deg C, Vdd = 5.0V+/-10%, Vss =0V

6.2.1Write mode

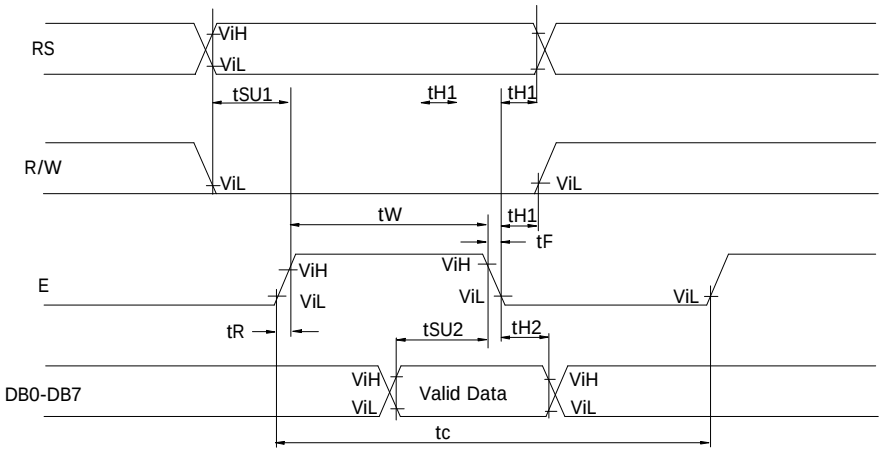
ITEM	SYMBOL	MIN	MAX	UNIT
E cycle time	tc	1200	-	ns
E rise time	tR	-	25	ns
E fall time	tF	-	25	ns
E-pulse width (H, L)	tw	140	-	ns
R/W and RS set-up time	tsul	0	-	ns
R/W and RS hold time	tH1	10	-	ns
Data set-up time	tsu2	40	-	ns
Data hold time	tH2	10	-	ns

6.2.2 Read mode

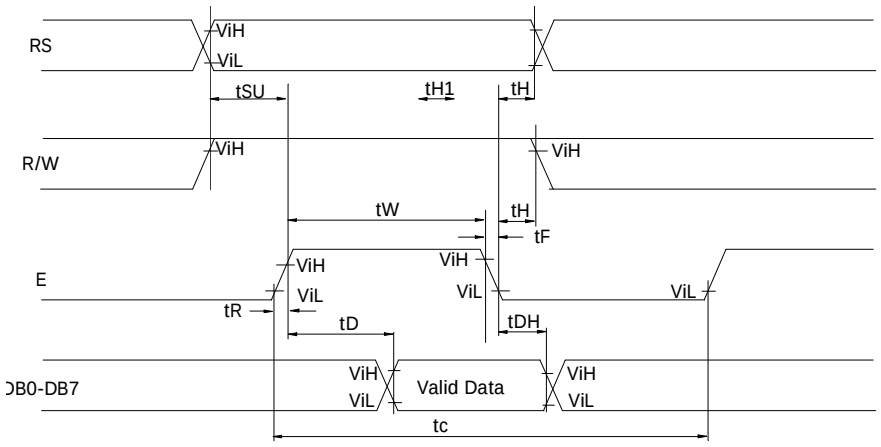
ITEM	SYMBOL	MIN	MAX	UNIT
E cycle time	tc	1200	-	ns
E rise time	tR	-	25	ns
E fall time	tF	-	25	ns
E-pulse width (H, L)	tw	140	-	ns
R/W and RS set-up time	tsu	0	-	ns
R/W and RS hold time	tH	10	-	ns
Data output delay	tD	-	100	ns
Data hold time	tDH	10	-	ns

6.2.3 Timing Diagram

Write Mode Timing Diagram

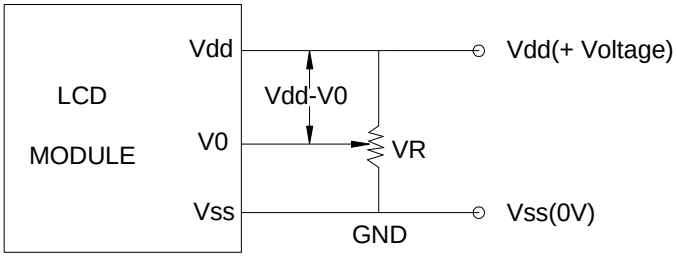


Read Mode Timing Diagram



7. Example of Power Supply

It is recommended to apply a potentiometer for the contrast adjust due to the tolerance of driving voltage and its temperature dependence.



Vdd – V0: LCD Driving Voltage
VR: 10K – 20K

8. ELECTRO-OPTICAL CHARACTERISTIC

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REF.
Contrast	CR	25℃	--	12	--		Note1
Rise Time	tr	25℃	--	160	240	ms	Note2
Fall Time	tf	25℃	--	100	150	ms	note 2
Viewing Angle	θ1-θ2	25℃	--	--	60	DEG	Note 3
	Ø1, Ø2		-40	--	40		
Frame Frequency	Ff	25℃	--	64	--	Hz	note 2

Note(1): Contrast ratio is defined under the following condition:

$$CR = \frac{\text{brightness of non-selected condition}}{\text{brightness of selected condition}}$$

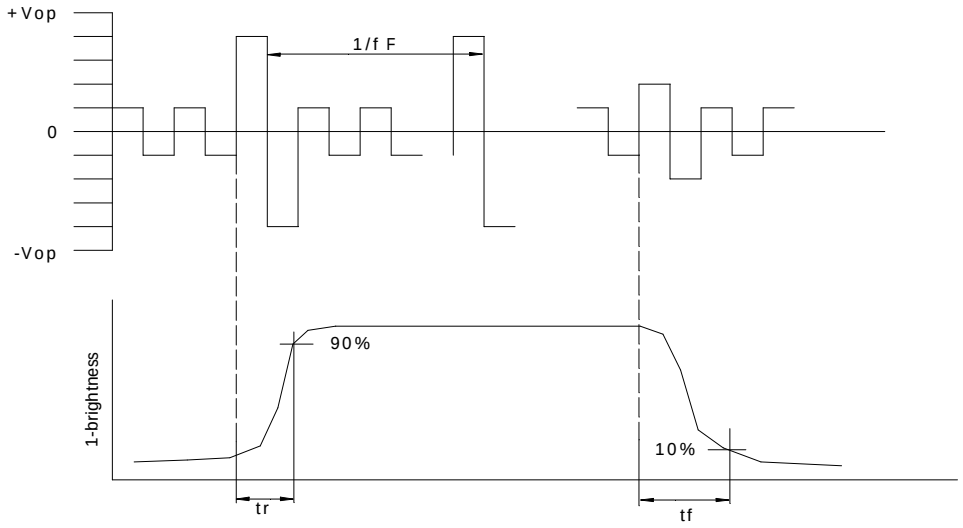
(a). Temperature----------25C

(b). Frame Frequency------64Hz

(c). Viewing angle----------θ=0, Ø=0

(d). Operating Voltage---4.5V

Note(2): definition of response time:



Condition:

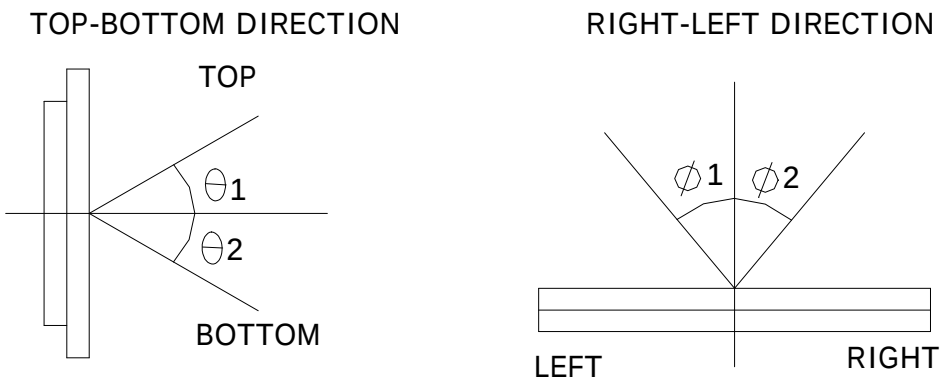
(a). Temperature----------25C

(b). Frame Frequency------64Hz

(c). Viewing angle----------θ=0, Ø=0

(d). Operating Voltage---4.5V

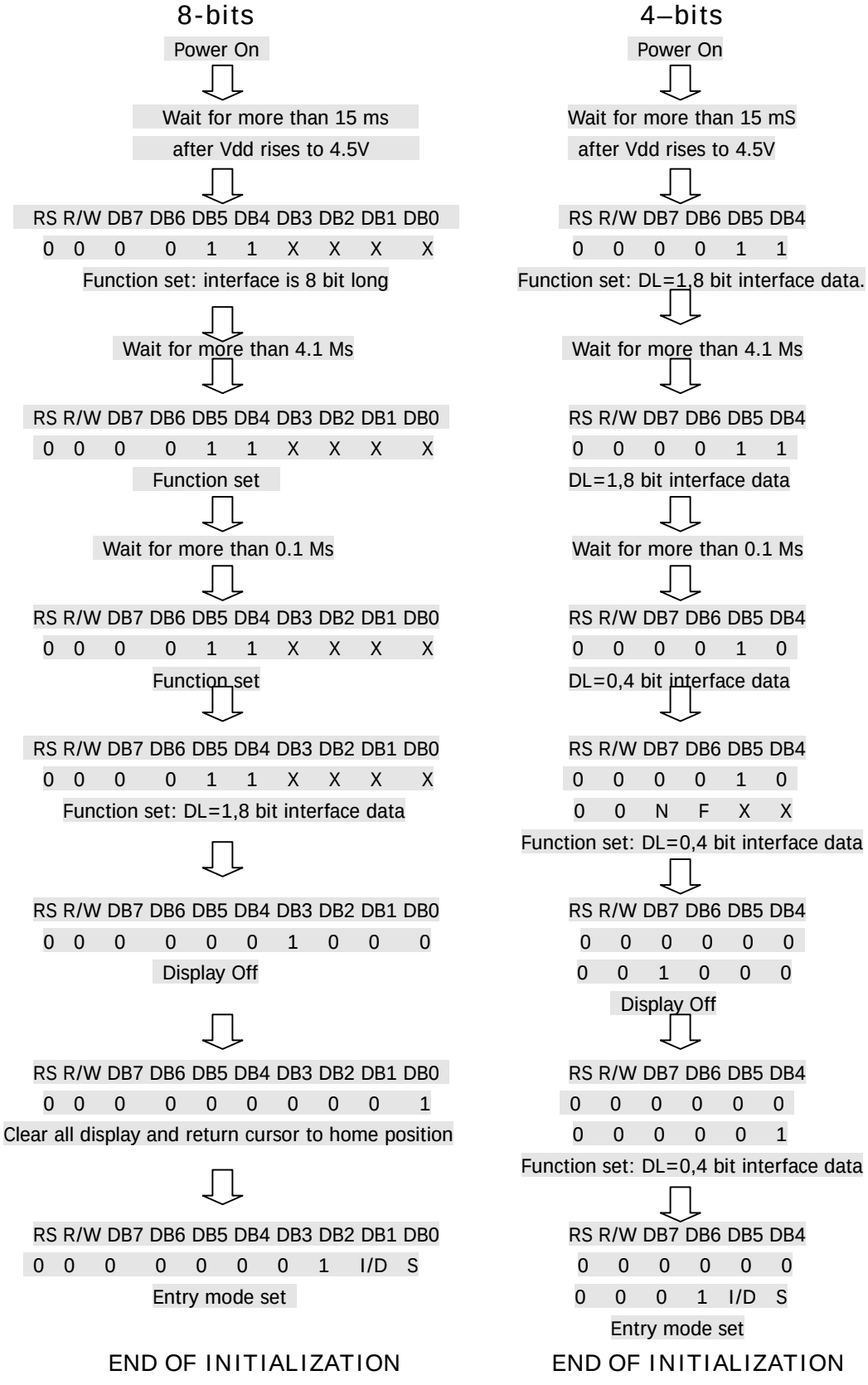
Note(3): definition of view angle:



9. INSTRUCTION TABLE

Function	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	Execu Time* (Max)
Clear Display	0	0	0	0	0	0	0	0	0	1	Clears entire display and returns the cursor to home position (address 0)	1.64mS
Return Home	0	0	0	0	0	0	0	0	1	X	Return the cursor to the home position. DD RAM contents remain unchanged. Set DD RAM address to zero.	1.64mS
Entry mode set	0	0	0	0	0	0	0	1	1/D	S	Set cursor moving direction and enable the shift of the display. These operations are performed during data write/read of DD RAM/CG RAM. 1/D=1: increment; 1/D=0: decrement; S=1: whole display shift when data is written.	40µS
Display ON/OFF control	0	0	0	0	0	0	1	D	C	B	Set display (D),cursor(C) and blinking of cursor(B) ON/OFF. D=1:display ON; D=0: display OFF. C=1:Cursor ON; C=0:cursot OFF. B=1:Blink ON; B=0, Blink OFF.	40µS
Cursor or Display shift	0	0	0	0	0	1	S/C	R/L	X	X	Move the cursor and shift the display without changing DDRAM contents. S/C=1: Display Shift; S/C=0:Cursor move. R/L=1:shift to right; R/L=0:shift to left.	40µS
Function Set	0	0	0	0	1	DL	N	F	X	X	Set interface data length (DL), number of display lines (N) and character font (F).DL=1: 8 bits; DL=0: 4 bits. N=1: 2 lines; N=0: 1 lines. F=1: 5X11 dots; F=0: 5X7 dots.	40µS
Set CG RAM add	0	0	0	1	ACG						Set CG RAM address. CG RAM data is sent and received after this setting.	40µS
Set DD RAM Add	0	0	1	ADD							Set DD RAM address. DD RAM data is sent and received after this setting.	40µS
Read BF & Addr	0	1	BF	AC							Read BUSY FLAG (BF) and the contents of the address counter. BF=1: internal operation; BF=0: can accept instruction.	0µS
Write Data to RAM	1	0	WRITE DATA								Write data into DD RAM or CG RAM.	40 µS**
Read Data from RAM	1	0	READ DATA								Read data from DD RAM or CG RAM.	40 µS**

10. INITIALIZATION BY INSTRUCTION



11. SOFTWARE EXAMPLES

8-BIT OPERATION 16 characters X 1 lines

Function	RS RW D7 D6 D5 D4 D3 D2 D1 D0	DISPLAY	DESCRIPTION
Power on delay			Initialization. No display appears.
Function set	0 0 0 0 1 1 0 0 X X		Sets 8-bit operation, 2-line display and 5*7 dots character font.
Display OFF	0 0 0 0 0 0 1 0 0 0		Turn off display.
Display ON	0 0 0 0 0 0 1 1 1 0		Turn on display and cursor.
Entry Mode set	0 0 0 0 0 0 0 1 1 0		Set mode to increment the address by one and to shift the cursor to the right, at the time of write to the DD/CG RAM. Display is not shifted.
Write data to CG/DD RAM	1 0 0 1 0 0 1 1 1 1	O	Write "O". Cursor incremented by one and shift to right.
Write data to CG/DD RAM	1 0 0 1 0 1 0 0 1 0	OR	Write "R". Cursor incremented by one and shift to right
Write data to CG/DD RAM	. . . . .	ORIENT	Write "I" “E” “N” “T”.
Set DDRAM address	0 0 1 1 0 0 0 0 0 0	ORIENT	Set RAM address so that the cursor is positioned at the 9th position
Write data to CG/DD RAM	. . . . .	ORIENT DS	Write "D" “S”.
Cursor or display shift	0 0 0 0 0 1 0 0 X X	ORIENT DS	Shift only the cursor position to the left.
Write data to CG/DD RAM	. . . . .	ORIENT DIS	Write "I" “S”

4-bit operation (4-bits 1 line)

Function	RS RW D7 D6 D5 D4	Display	Description
power on delay			Initialization. No display appears.
Function set	0 0 0 0 1 0		Sets to 4 -bit operation. In this case, operation is handled as 8-bits by initialization, and Only this instruction completes with one write.
Function set	0 0 0 0 1 0 0 0 0 0 X X		Sets 4 -bit operation, 1-line display and 5*7 dot character font. (number of display lines and character fonts cannot be changed hence after.)
Display ON/OFF Control	0 0 0 0 0 0 0 0 1 1 1 0	_	Turn on display and cursor.
Entry Mode Set	0 0 0 0 0 0 0 0 0 1 1 0	_	Turn on display and cursor.
Write data to CG/DD/ARM	1 0 0 1 0 0 1 0 1 1 1 1		Write "O". Cursor incremented by one and shift to right.
same as 8-bit operation			

12.Quality units

12.1 Purpose

This standard for quality assurance should define the quality of LCD module products to customer by EASTERNTIONIC LCD GROUP.

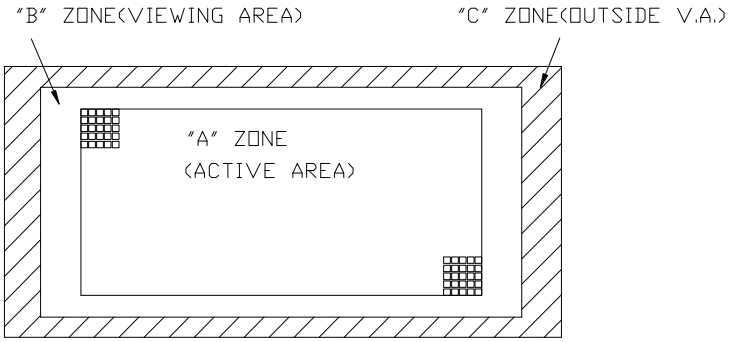
12.2 Scope

This document defines general provisions as well as inspection standards for LCD module supplied by EASTERNTIONIC LCD GROUP,except for those with special requirements from customer.

12.3 Definition

12.3.1 Definition of area

A Zone: Active area.
B Zone: Viewing area
C Zone: Outside viewing area.



12.3.2 Definition of size

Large size(L): 1~6 pcs LCD screens are cut out of from each 14"×16" mother glass.
Middle size(M): 7~50 pcs LCD screens are cut out of from each 14"×16" mother glass.
Small size(S): more than 50 pcs LCD screens are cut out of from each 14"×16" mother glass.

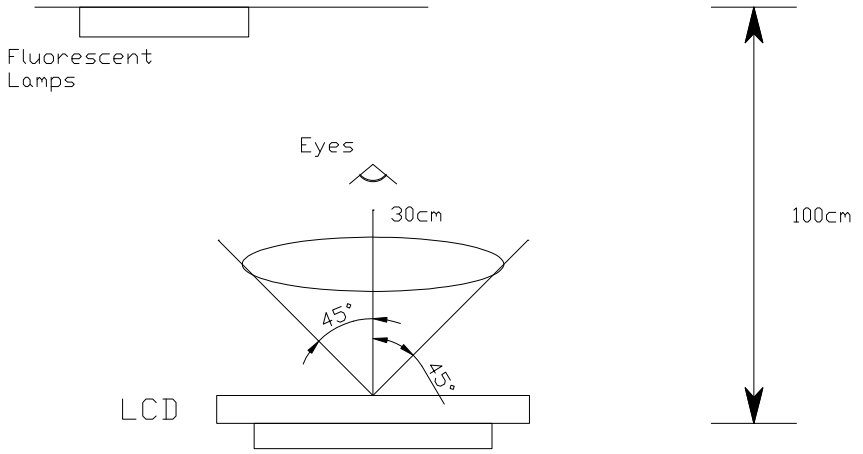
12.4 Quality Specification

12.4.1 Conditions of Cosmetic Inspection

12.4.1 Test should be conducted under the following conditions:

Ambient temperature :22±5℃.
Ambient humidity: 65±20%RH
Ambient Luminance: 40-watt fluorescent lamp.
An appearance test should be conducted by human sight at approximately 30 cm distance

from the LCD module under fluorescent light. Distance between LCD and fluorescent lamps should be 100 cm or more. Viewing direction for inspection is 45° from vertical against LCD.



12.4.1.2 When test the model of transmissive product must add the reflective plate.

12.4.2 Sampling plan

Unless otherwise agreed in writing, the sampling inspection shall be applied to the incoming inspection of customer.

- Lot size: Quantity of shipment lot per model
- Sampling type: Normal inspection,single sampling
- Sampling Level: Level Ⅱ
- Sampling table: GB/T2828.1.1(GB-national standard of China)

12.4.3 Classification of defects and Acceptable quality level

Defects and classified as either a major or minor defect defined as bellows:

- Major defect: It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.
- Minor defect: It is a defect that will not result in functioning problem with deviation calssifiec.

The AQL for major and minor defects is defined as follows:

Partition	Definition	AQL
Major defect	Functional defective as product	0.4
Minor defect	Satisfy all functions as product but not satisfy cosmetic standard	1.0

12.4.4 Applicable instrument

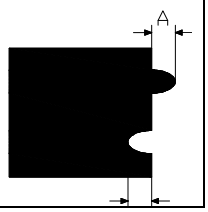
- LCD module tester

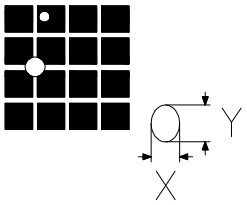
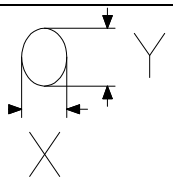
- Multimeter
- Caliper
- Defect size filming standard

12.4.5 Inspection quality criterion

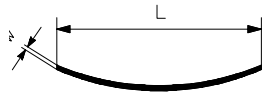
12.4.5.1 LCD panel part

The inspection specification as following list:

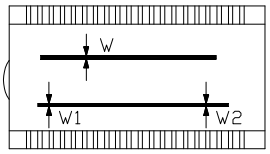
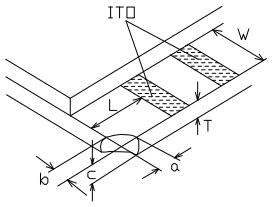
Classify	**Item**	**Description of defects**	**Inspection criterion**		**Drawing specification**
Major defect	1.Non-display	Product no function	Not accept		
	2.LCD with wrong view direction`	Difference in Spec.	Not accept		
	3.Segment missing	Part or all pattern do not light up	Not accept		
	4.Occur high current	Current exceed designed value	Not accept		
	5. LC leakage	LC does not fulfill the glass cell	Not accept		
	6.Deviation from drawing	LCM Dimension difference from drawing and over tolerance	According to dimensions noted in the specification		
	7.Wrong type applied	Wrong polarizer attachment	Not accept		
		Pin attached wrong type applied	Not accept		
	8.Incorrect pins quality	Pin attached wrong quantity applied	Not accept		
Minor defect	9.Pattern deformation	Segment fatter or smaller	Dimension (mm)	Acceptable number	
			A≤0.1	Not count (Should not be connected to next dot)	

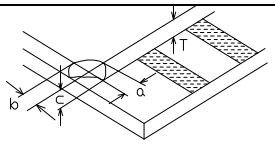
			0.10<A≤0.15	1 pc / dot(only segment)or less 2 pcs / cell or less (Should not be connected to next dot)	
			B ≤ 0.10	Not count	
Minor defect	10.Pinholes	Black spot/white spot at activated state	1. large size LCD Accept if can't be found at 1m distance and will not enlarge under electronic test 2. Middle size LCD Diameter(mm) Accept QTY Φ≤ 0.15 Not count 0.15<Φ≤ 0.25 3 0.25<Φ≤ 0.35 1 Φ >0.35 0 3. Small size LCD Diameter(mm) Accept QTY Φ≤ 0.15 Not count 0.15<Φ≤ 0.25 2 0.25<Φ≤ 0.30 1 Φ >0.30 0 4. For the dot pattern: accept if the area of defect is less than or equal to half of one lattice's 5. Only allow one defect in one segment 6. The nearest diatance allowed between two pinholes is 20mm	 Φ=(X+Y)/2
	11.Blemishes and foreign matters	Black spot/dust on LCD(non-display)	**Positive panel:** **1.A zone** - Large size LCD Accept if can't find at 1m distance and will not enlarge under electronic test: -Middle size LCD Diameter(mm) Accept QTY Φ≤ 0.15 Not count 0.15<Φ≤ 0.25 3 0.25<Φ≤ 0.35 1	 Φ=(X+Y)/2

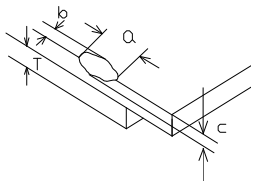
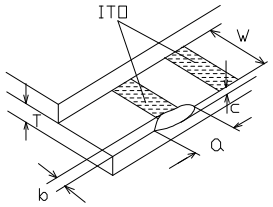
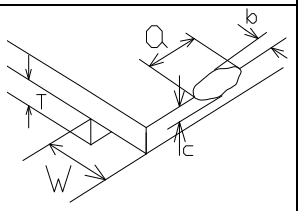
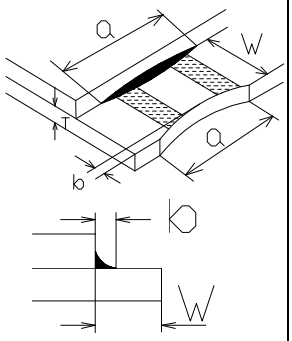
			$\Phi > 0.35$ 0 -Small size LCD Diameter(mm) Accept QTY $\Phi \le 0.15$ Not count $0.15 < \Phi \le 0.25$ 2 $0.25 < \Phi \le 0.30$ 1 $\Phi > 0.30$ 0 **2.B zone** 1.5 times of acceptable largest diameter size of Zone A **3.C zone** Notcount. **Negative panel:** **1. A zone** -Large size LCD Diameter(mm) Accept QTY $\Phi \le 0.15$ Not count $0.15 < \Phi \le 0.30$ 4 $0.30 < \Phi \le 0.50$ 1 $\Phi > 0.50$ 0 -Middle&small size LCD Diameter(mm) Accept QTY $\Phi \le 0.15$ Not count $0.15 < \Phi \le 0.25$ 3 $\Phi > 0.25$ 0 **2. B zone** 1.5 times of acceptable largest diameter size of Zone A **3.C zone** No count The nearest diatance allowed between two black spot is 20mm	

	12.Black lines and scratches	Scratch on glass or polarizer surface.And foreign linear matters in LCD	**Positive panel:** **1.A zone** - Large size LCD Accept if can't find at 1m distance and will not enlarge under electronic test. -Middle size LCD Diameter(mm) Accept QTY W≤ 0.02 Not count 0.02< W≤ 0.03,L ≤4 2 0.03< W ≤ 0.05,L ≤3 2 0.02< W≤ 0.03,L ＞4 0 0.03< W ≤ 0.05,L ＞3 0 W＞0.05 As the spot criteria. -Small size LCD Diameter(mm) Accept QTY W≤ 0.02 Not count 0.02< W≤ 0.03,L ≤4 2 0.03< W ≤ 0.05,L ≤2 1 0.02< W≤ 0.03,L ＞4 0 0.03< W ≤ 0.05,L ＞2 0 W＞0.05 As the spot criteria. **2.B zone** 1.5 times of acceptable largest diameter size of Zone A **3.C zone** Notcount. **Negative panel:** **1. A zone** -Large size LCD Diameter(mm) Accept QTY W≤ 0.02 Not count 0.02< W≤ 0.03,L ≤5 3 0.03< W ≤ 0.05,L ≤4 2 0.02< W≤ 0.03,L ＞5 0 0.03< W ≤ 0.05,L ＞4 0 W＞0.05 As the spot criteria.	

			-Middle size LCD Diameter(mm) Accept QTY W≤ 0.02 Not count 0.02< W≤ 0.03,L ≤4 2 0.03< W ≤ 0.05,L ≤2 2 0.02< W≤ 0.03,L ＞3 0 0.03< W ≤ 0.05,L ＞2 0 W＞0.05 As the spot criteria. -Small size LCD Diameter(mm) Accept QTY W≤ 0.02 Not count 0.02< W≤ 0.03,L ≤3 2 0.03< W ≤ 0.05,L ≤3 1 0.02< W≤ 0.03,L ＞3 0 0.03< W ≤ 0.05,L ＞2 0 W＞0.05 As the spot criteria. **2. B zone** 1.5 times of acceptable largest diameter size of Zone A **3.C zone** Not count The nearest diatance allowed between two defects is 20mm	
Mintor defect	13. Scratch on PI coating	PI coating scratched	The visible scratch of A zone can not be accepted at 30cm view distance.	
Mintor defect	14. Rainbow	Arches,circular or parallel colorful spread	According to the limit specimen	
Mintor defect	15. Bubbles or wrinkles in polarizer	Bubbles or wrinkles between polarizer and glass	A zone:The visible defect can not be accepted at 30cm view distance. B zone: Not count	
Mintor defect	16. Position of polarzer attachment	Wrong polarizer attachment in position or dimension	Polarizer protruding from edge of glass and exceeding/within the maximum external dimension of LCD	

<table>
<tr><td rowspan="4">Mintor defect</td><td rowspan="4">17. Ink printing defect</td><td>17.1 Ink line/pattern broken</td><td colspan="4">Not accept</td><td rowspan="3"></td></tr>
<tr><td>17.2 Ink pattern/line jagged</td><td colspan="4">Accept if the thick or thin part is less than equal to 25% segment width, or according to the limit specimen</td></tr>
<tr><td>17.3 Light leakage</td><td colspan="4">When activated with current white light appears in the position of pinhole or scratch due to ink printing misalignment.According to the pinhole specification.</td></tr>
<tr><td>17.4 Ink printing pattern/line uneven</td><td colspan="4">Reject if the thick or thin in more than 1/2W.
Reject when W1-W2≤1/3W</td><td> 
</td></tr>
<tr><td>Mintor defect</td><td>18. Pin defect</td><td>18.1 Corrosion or foreign material on terminal legs</td><td colspan="4">Pin incoming defect: oxidized,damage(including pins plating damaged),excess epoxy on bottom glass or terminal legs.Not accept.</td><td rowspan="2"></td></tr>
<tr><td>18.2 Pin deviation over tolerance</td><td colspan="4">According to the specification</td></tr>
<tr><td rowspan="4">Mintor defect</td><td rowspan="4">19. Chipped glass on comer</td><td rowspan="3">19.1 Chip in lead contact area.</td><td>a</td><td>b</td><td>c</td><td>accept QTY</td><td rowspan="3"> 
</td></tr>
<tr><td>a≤5mm
L>5mm</td><td>b≤W</td><td>c≤T</td><td>3</td></tr>
<tr><td>a<L

L<5mm</td><td>b≤W</td><td>c≤T</td><td>3</td></tr>
<tr><td>19.2 Others</td><td colspan="3">Not exceed 1/2 width of seal</td><td>c≤T</td><td>3</td><td> 
</td></tr>
<tr><td></td><td></td><td></td><td colspan="3"></td><td></td><td></td></tr>
</table>

Mintor defect	20. Glass chip on edge		a	b	c	accept QTY	
			a≤5mm	Not exceed 1/2 width of seal	c≤T	3	
Mintor defect	21. Clipped electrode pad	21.1Glass chip on ITO edge	a	b	c	accept QTY	
			a≤4mm (and not exceed 4 ITO termina l	b≤W/4	c≤T	3	
		21.2 Glass chip on ITO back	a	b	c	accept QTY	
			a≤5mm	b≤W/3	c≤T	3	
Mintor defect	22. Mechanical damage	Extended crack inspector shall attempt to remove the chip with tweezers,re-eval uate if the remaining defect is still a crack or a chip	b		accept QTY		
			b≤W/4		2		
Mintor defect	23.Glass cracks		Not accept				

Remark:
The minimum space between any 2 defects(spot,dirt) should more than 20mm, and max. allowed defect QTY in total:
Large size LCD: Zone A≤ 5/unit, Zone B≤ 5/unit;
Middle size LCD: Zone A≤ 3/unit, Zone B≤ 3/unit;
Small size LCD: Zone A≤ 2/unit, Zone B≤ 2/unit;

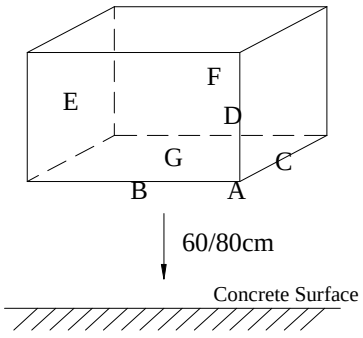
12.4.5.2 Other part

The inspection specification as following list:

NO.	Items	Criterion of defects	AQL
1	Backlight	1. Lumination source flickers. 2. Using spot, lines and contamination standard of LCD to judge the spots or scratches defect on backlight. 3. Not allow unlighted on backlight. 4. Colour and luminance of backlight should correspond its specification.	Major Minor Major Major
2	PCB,COB	1.COB seal may not have pinholes larger than0.2mm or contamination. 2.COB seal surface may not have pinholes through to the IC. 3. The height of COB should not exceed the height indicated in the assembly diagram. 4. Beyond 2mm of the seal area, there may not have sealant on the PCB. 5.No oxidation or contamination on PCB connector. 6.Parts on PCB should correspond the characteristic,and not allow wrong parts,missing parts or additional parts. 7.The jumper on the PCB should correspond to the characteristic. 8.The solder which gets on bezel,LED pad,zebra pad or screw hole pad should be smoothed down.	Minor Minor Major Minor Minor Major Minor Major
3	Soldering	1. No unmelted solder pastes on the PCB. 2. No cold solder joints,solder connection missing,oxidation of solder. 3. No short circuits in components on PCB.	Minor Minor Minor
4	General Appearance	1. No oxidation, contamination, curves,cracks or bends on interface Pin of TCP. 2. No solder residue or solder balls on product. 3. The IC on TCP may not be damaged. 4. The residual rosin or tin oil of soldering(component or chip component) is not turned into brown or black colour. 5. Packing method correspond the specification. 6. Dimension and structure correspond the specification sheet. 7. No dirt and break on the heat seal.	Minor Minor Major Minor Major Major Major

12.5 Reliability

The LCD module shall not fail the following reliability test.

<table>
<tr><th>Item</th><th colspan="2">Condition</th><th>Criterion</th></tr>
<tr><td>High temperature operation</td><td colspan="2">+50℃±2℃， 8 hours</td><td rowspan="10">1.Total current consumption should be below double of initial value.
2.Cosmetic defects should not be happened</td></tr>
<tr><td>Low temperature operation</td><td colspan="2">-10℃±2℃， 8 hours</td></tr>
<tr><td rowspan="2">Humidity</td><td>Operation</td><td>40℃±2℃,93%±2%RH,8 hours</td></tr>
<tr><td>Storage</td><td>40℃±2℃,93%±2%RH, 24 hours</td></tr>
<tr><td>High temperature storage</td><td colspan="2">+60℃±2℃， 10 hours</td></tr>
<tr><td>Low temperature storage</td><td colspan="2">-10℃±2℃， 10 hours</td></tr>
<tr><td>Thermal shock storage</td><td colspan="2">0℃~ +50℃
60min~60min, 5 cycles</td></tr>
<tr><td>Vibration test</td><td colspan="2">Amplitude:0.7~1.0mm,frequency:50Hz,30min in each direction(X,Y,Z)</td></tr>
<tr><td>Shock test</td><td colspan="2">To be measured after dropping from 60cm or 80cm high on the concrete surface in packing state.(weight≥15Kg,dropping height 60cm; Weight＜15Kg,dropping height 80cm)
 

Dropping method
corner dropping
A corner: once
Edge dropping
B,C,D edge: once
Face dropping
E,F,G face: once</td></tr>
<tr><td colspan="4">Remark: The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.</td></tr>
</table>

13. Character Pattern

14. PRECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handing,

(1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degredation, polarizer peel off or bubble.

(2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface. Wipe gently with cotton. Chamois or other soft material soaked in petroleum benzin.

(3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.

(4). Glass can be easily chipped or cracked from rough handing. especially at corners and edges.

(5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

(1). Do not tamper in any way with the tabs on the tabs on the metal frame.

(2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattem.

(3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).

(4). When mounting a LCM make sure that the PCB is not under any tress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

(5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

(1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.

(2). The modules should be kept in antistatic bags or other containers resistant to static for storage.

(3). Only properly grounded soldering irons should be used.

(4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5). The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

(6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

2.3. Soldering

(1). Solder only to the I/O terminals.

(2). Use only soldering irons with proper grounding and no leakage.

(3). Soldering temperature: 280 ℃±10℃

(4). Soldering time: 3 to 4 sec.

(5). Use eutectic solder with resin flux fill.

(6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4. Operation

(1). The viewing angle can be adjusted by varying the LCD driving voltage V0.

(2). Driving voltage should be kept within specified range; excess voltage shortens display life.

(3). Response time increases with decrease in temperature.

(4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".

(5). Mechanical disturbance during operation (such as pressing on the viewing area) nay cause the segments to appear "fractured".

2.5. Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

2.6. Limited Warranty

Unless otherwise agreed between ORIENT DISPLAY and customer, ORIENT DISPLAY will replace or repair any of its LCD and LC, which is found to be defective electrically and visually when inspected in accordance with ORIENT DISPLAY acceptance standards, for a period on one year from data of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of ORIENT DISPLAY is limited to repair and/or replacement on the terms set forth above. ORIENT DISPLAY will not responsible for any subsequent or consequential events.

15. Declaration of conformity regarding the limitation of dangerous substances

深圳易事通液晶显示模块有限公司

SHENZHEN EASTERNTRONIC LCM CO ., LTD.

4F, B3 Building, FuYuan Industrial Zone, FuYong Town,

BaoAn District, ShenZhen, P.R.China

DECLARATION OF CONFORMITY REGARDING THE LIMITATION OF DANGEROUS SUBSTANCES.

WE , SHENZHEN EASTERNTRONIC LCM CO ., LTD,
Declare that the product of CS1602B-D-YSNFDYN-122 complies with:
The directive 2002/95/EC Dated 2003/01/27 regarding the limitation of dangerous substances, in particular to clause 4 which forbids the use of the following elements:

- ●Lead
- ●Mercury
- ●Cadmium
- ●Hexavalant chromium
- ●Polybrominated biphenyls
- ●Polybrominated diphenylethers

And to the annex which points out the exempted implementations
□ To the directive 73/23/eec dated 1973/02/19 and the standard EN60335-1 regarding prohibition of following elements:

- ● Oils containing polychlorinated bipheny1
- ● Asbestos
- ● Radioactive substances

Name: DING
SHENZHEN EASTERNTRONIC LCM CO ., LTD.
Issued on March 4, 2009
According with the proposal of Technical Adaption Committee(TAC) of a limit of 0.1% by weight for lead hexavalent chromium, mercury, PBBs and PBDRs and 0.01% by weight for Cadmium.